

5mm Round Standard T-1 3/4 With Flange Type Phototransistor Technical Data Sheet

Part No.: 503PTC2E-1AD

Spec No.: B508 X335 Rev No.: V.3 Date: May./23/2006 Page: 1 OF 7

Approved: JoJo Checked: Wu Drawn: Wang



Features:

5mm round standard t-1 3/4 package.

Fast response time.

High photo sensitivity.

Small junction capacitance.

The product itself will remain within RoHS compliant Version.

Descriptions:

The 503PT is a high speed and high sensitive silicon NPN phototransistor in a standard Φ 5 package.

Due to its clear epoxy, the device is matched to visible light and infrared radiation.

Applications:

Infrared applied system.

Optoelectronic automatic control system.

Optoelectronic switch.

Camera.

Printer.

Counters and sorters.

Encoders.

Floppy disk drive.

Video camera, tape and card readers.

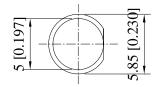
Position sensors.

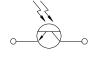
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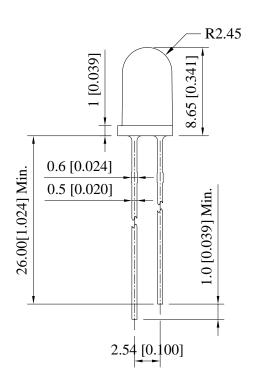
Package Dimension:

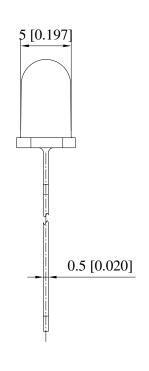




EMITTER COLLECTOR

POLARITY





Part No.	Chip Material	Lens Color	Source Color
503PTC2E-1AD	Silicon	Water Clear	Phototransistor

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.25 mm (.010") unless otherwise specified
- 3. Protruded resin under flange is 1.00 mm (.039") max.
- 4. Specifications are subject to change without notice.

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Absolute Maximum Ratings at Ta=25

Parameters	Symbol	Rating	Unit
Power Dissipation	P _D	75	mW
Collector-Emitter Voltage	V _{CEO}	30	V
Emitter-Collector-Voltage	V _{ECO}	5	V
Collector Current	I_{C}	20	mA
Operating Temperature	T _{OPR}	-40 to	+85
Storage Temperature	T _{STG}	-40 to	+100
Lead Soldering Temperature	T _{SOL}	260 for 5 Seconds	

Electrical Optical Characteristics at Ta=25

Parameters	Symbol	Min.	Тур.	Max.	Unit	Condition
Collector-Emitter Breakdown Voltage	BV _{CEO}	30			V	I _C =100μA, Ee=0mW/cm²
Emitter-Collector Breakdown Voltage	BV _{ECO}	5			V	I _E =100μΑ, Ee=0mW/cm²
Collector-Emitter Saturation Voltage	V _{CE(SAT)}			0.40	V	I _C =0.70mA, Ee=1mW/cm ²
Collector Dark Current	\mathbf{I}_{CEO}			100	nA	Ee=0mW/cm², V _{CE} =20V
On-State Collector Current	$I_{C(ON)}$	0.70	2.00		mA	Ee=1mW/cm², V _{CE} =5V
Optical Rise Time (10% to 90%)	T _R		15		ns	V_{CE} =5V, I_{C} =1mA, R_{L} =100 Ω
Optical Fall Time (90% to 10%)	T_{F}		15		115	
Reception Angle	2θ _{1/2}		30		Deg	
Wavelength Of Peak Sensitivity	λР		940		nm	
Rang Of Spectral Bandwidth	λ0.5	400		1100	nm	

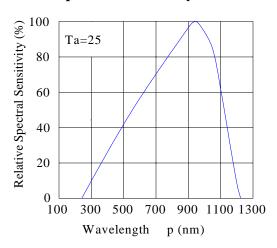
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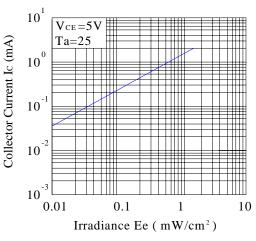


Typical Electrical / Optical Characteristics Curves (25 Ambient Temperature Unless Otherwise Noted)

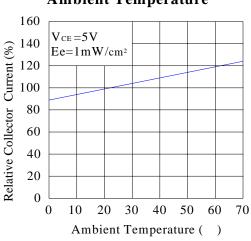
Spectral Sensitivity



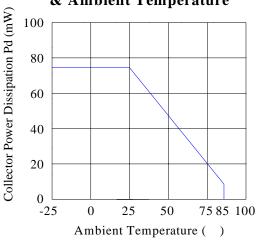
Collector Current & Irradiance



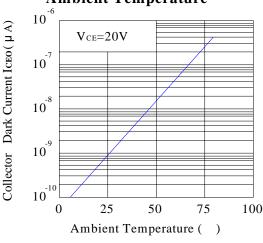
Relative Collector Current & Ambient Temperature



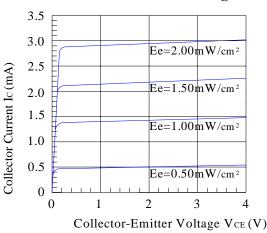
Collector Power Dissipation & Ambient Temperature



Collector Dark Current & Ambient Temperature



Collector Current & Collector-Emitter Voltage



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Reliability Test Item And Condition:

The reliability of products shall be satisfied with items listed below:

Confidence level: 90%.

LTPD: 10%.

No ·	Item	Test Conditions	Test Hours/ Cycles	Sample Sizes	Failure Judgment Criteria	Ac/ Re
1	Reflow Soldering	TEMP.: 260 <u>+</u> 5 5secs	6mins	22pcs		0/1
2	Temperature Cycle	H: +100 15mins 5 mins L: -40 15mins	50Cycles	22pcs		0/1
3	Thermal Shock	H: +100 15mins 10secs L: -10 5mins	50Cycles	22pcs	Ic _(ON) L×0.8	0/1
4	High Temperature Storage	TEMP.: +100	1000hrs	22pcs	Specification Limit	0/1
5	Lower Temperature Storage	TEMP.: -40	1000hrs	22pcs		0/1
6	DC Operating Life	V _{CE} =5V	1000hrs	22pcs		0/1
7	High Temperature/ High Humidity	85 / 85% R.H	1000hrs	22pcs		0/1

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Please read the following notes before using the product:

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30 or less and 80%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30 or less and 60%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

3. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260 for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

4. Soldering

When soldering, for Lamp without stopper type and must be leave a minimum of 3mm clearance from the base of the lens to the soldering point.

To avoided the Epoxy climb up on lead frame and was impact to non-soldering problem, dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Soldering Iron		Wave Soldering		
Temperature Soldering Time	300 Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat Time Solder Wave Soldering Time	100 Max. 60 sec. Max. 260 Max.	

Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED.

Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

6. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices equipment and machinery must be properly grounded.

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